

APPLICATION DATA SHEET

Electronic Version 0.0.11

Stylesheet Version: 1.0

Attorney Docket Number: JCLA9702

Publication Filing Type: new-utility

Application Type: utility

Title of Invention: CHIP PACKAGE STRUCTURE

Customer Number Attorney: 23900



Customer Number Correspondence Address: 23900



Foreign Priority:

91213810 TW 2002-09-03

Priority Claimed

Assignee (Publish): VIA TECHNOLOGIES, INC.

TAIPEI HSIEN TW

INVENTOR(s):

Primary Citizenship: TAIWAN

Given Name: JIMMY

Family Name: HSU

Residence City: TAIPEI HSIEN

Residence Country: TW

Address:

TAIPEI HSIEN , TW